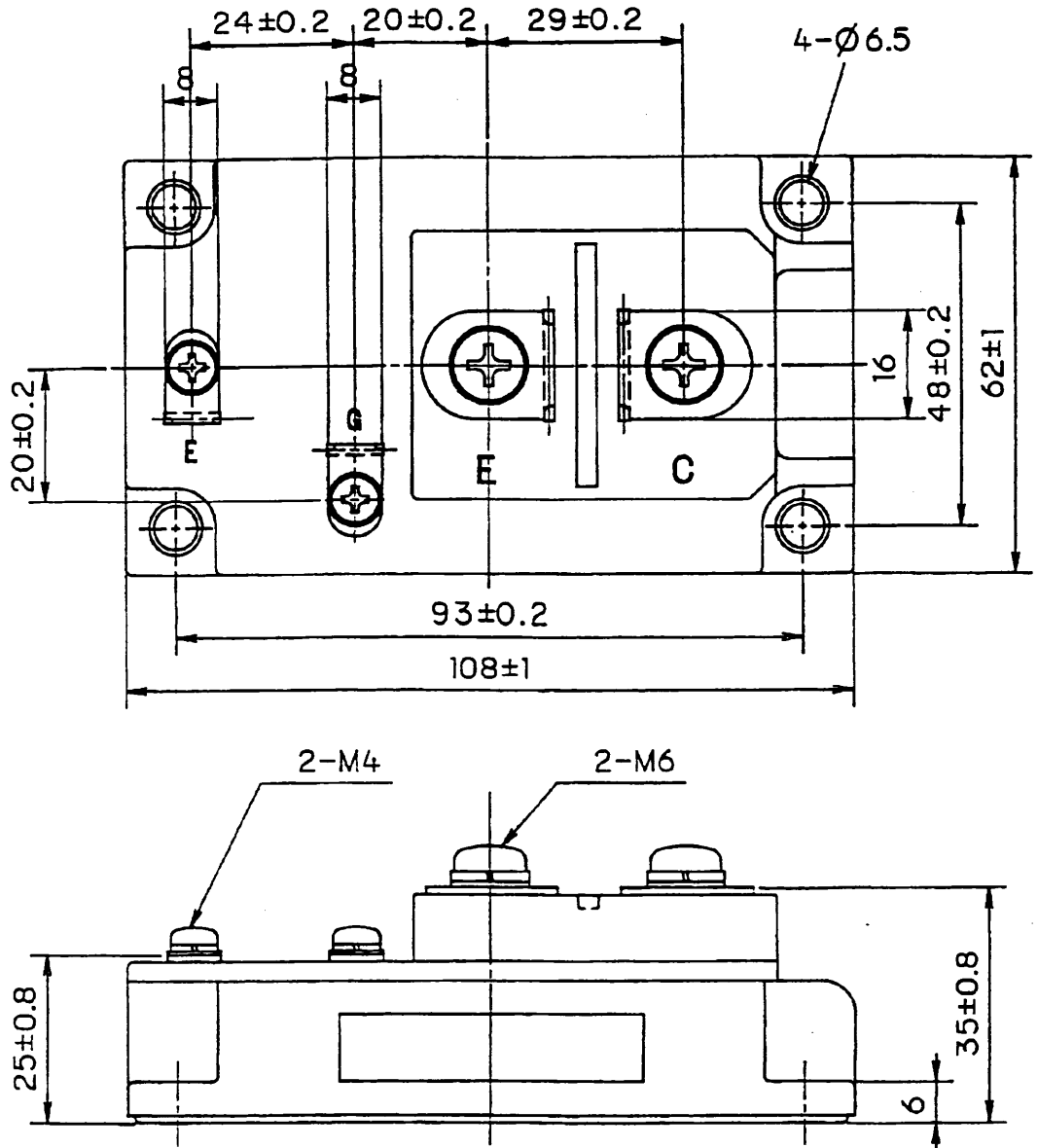
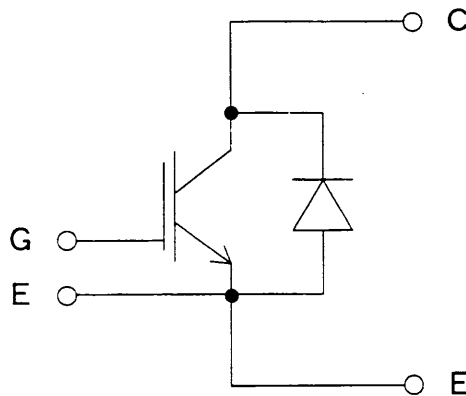


# Target Specification of 1MBI200S-120

## 1. Outline Drawing ( Unit : mm )



## 2. Equivalent circuit



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DATE	NAME	APPROVED
DRAWN Feb -11 -99	N. Arakawa	
CHECKED Feb -11 -99	S. Hata	T. Miyazaki

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3. Absolute Maximum Ratings ( at Tc= 25°C unless otherwise specified )

Items	Symbols	Conditions	Maximum Ratings	Units	
Collector-Emitter voltage	V <sub>CES</sub>		1200	V	
Gate-Emitter voltage	V <sub>GES</sub>		±20	V	
Collector current	I <sub>c</sub>	Continuous	Tc=25°C	300	A
			Tc=80°C	200	
	I <sub>c</sub> pulse	1ms	Tc=25°C	600	
			Tc=80°C	400	
			-I <sub>c</sub>	200	
-I <sub>c</sub> pulse	1ms	400			
Collector Power Dissipation	P <sub>c</sub>	1 device	1300	W	
Junction temperature	T <sub>j</sub>		150	°C	
Storage temperature	T <sub>stg</sub>		-40~ +125	°C	
Isolation voltage <sup>(#1)</sup>	V <sub>iso</sub>	AC : 1min.	2500	V	
Screw Torque	Mounting <sup>(#2)</sup>		3.5	N·m	
	Terminals <sup>(#3)</sup>		4.5		
	Terminals <sup>(#4)</sup>		1.7		

(#1) All terminals should be connected together when isolation test will be done.

(#2) Recommendable Value : 2.5~3.5 N·m (M5) or (M6)

(#3) Recommendable Value : 3.5~4.5 N·m (M6)

(#4) Recommendable Value : 1.3~1.7 N·m (M4)

4. Electrical characteristics ( at Tj= 25°C unless otherwise specified)

Items	Symbols	Conditions	Characteristics			Units
			min.	typ.	Max.	
Zero gate voltage Collector current	ICES	V <sub>GE</sub> = 0 V, V <sub>CE</sub> = 1200 V			4.0	mA
Gate-Emitter leakage current	IGES	V <sub>CE</sub> = 0 V, V <sub>GE</sub> = ±20 V			0.8	μA
Gate-Emitter threshold voltage	V <sub>GE(th)</sub>	V <sub>CE</sub> = 20 V, I <sub>c</sub> = 200 mA	5.5	7.2	8.5	V
Collector-Emitter saturation voltage	V <sub>CE(sat)</sub>	V <sub>GE</sub> = 15 V, T <sub>j</sub> = 25 °C		2.3	2.6	V
		I <sub>c</sub> = 200 A, T <sub>j</sub> = 125 °C		2.8		
Input capacitance	C <sub>ies</sub>	V <sub>GE</sub> = 0 V		24000		pF
Output capacitance	C <sub>oes</sub>	V <sub>CE</sub> = 10 V		5000		
Reverse transfer capacitance	C <sub>res</sub>	f = 1 MHz		4400		
Turn-on time	t <sub>on</sub>	V <sub>cc</sub> = 600 V			1.2	μs
	t <sub>r</sub>	I <sub>c</sub> = 200 A			0.6	
	t <sub>r(1)</sub>	V <sub>GE</sub> = ±15 V		0.1		
Turn-off time	t <sub>off</sub>	R <sub>G</sub> = 4.7 Ω			1.0	μs
	t <sub>f</sub>			0.08	0.3	
Forward on voltage	V <sub>F</sub>	I <sub>F</sub> = 200 A	T <sub>j</sub> = 25 °C	2.4	3.3	V
			T <sub>j</sub> = 125 °C	2.0		
Reverse recovery time	t <sub>rr</sub>	I <sub>F</sub> = 200 A			0.35	μs

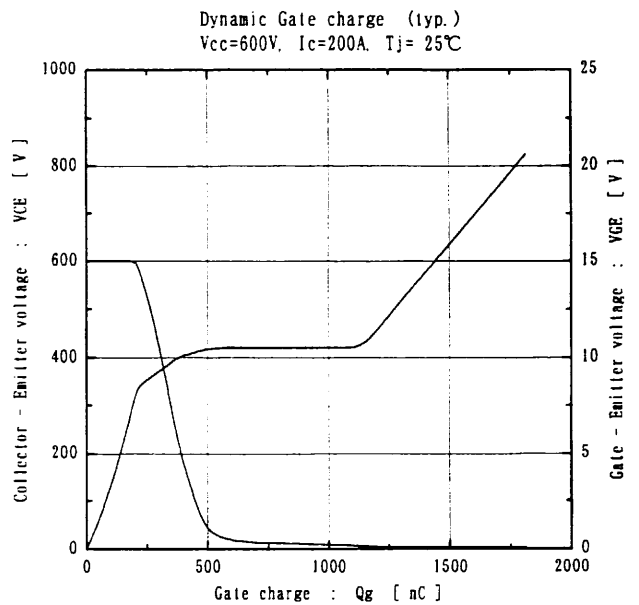
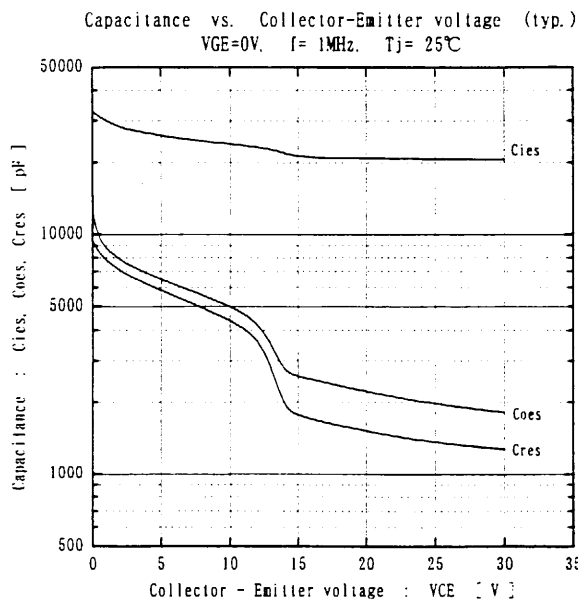
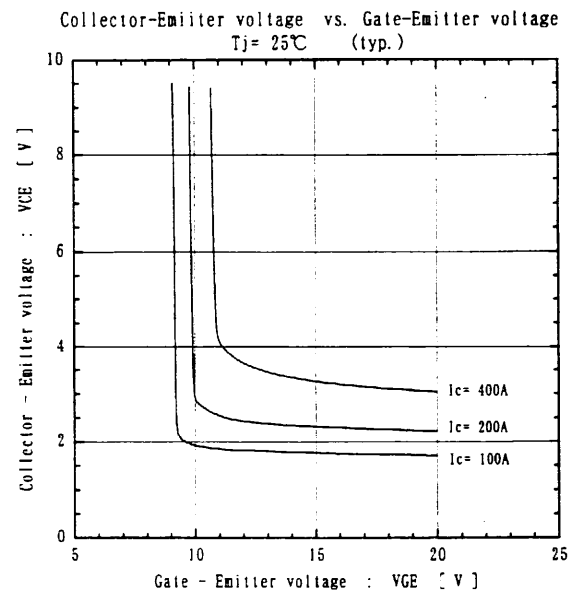
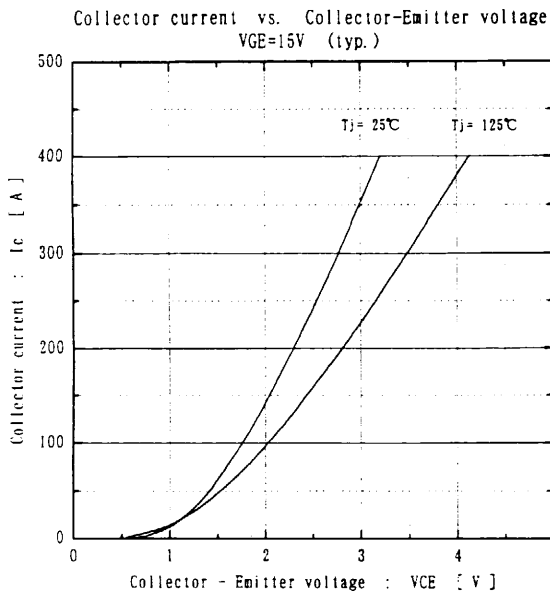
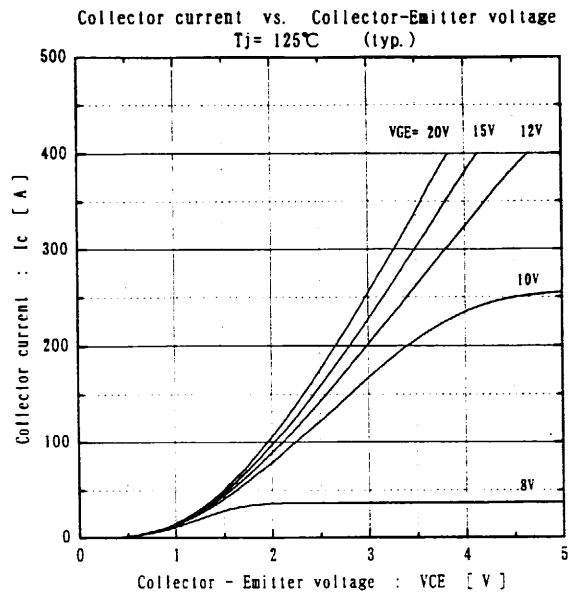
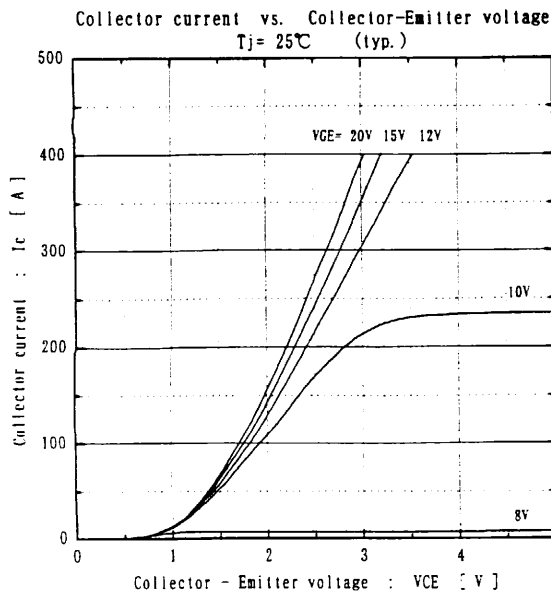
5. Thermal resistance characteristics

Items	Symbols	Conditions	Characteristics			Units
			min.	typ.	Max.	
Thermal resistance (1 device)	R <sub>th(j-c)</sub>	IGBT			0.096	°C/W
		FWD			0.260	
Contact Thermal resistance	R <sub>th(c-f)</sub>	with Thermal Compound <sup>(*)</sup>		0.0125		

\* This is the value which is defined mounting on the additional cooling fin with thermal compound.

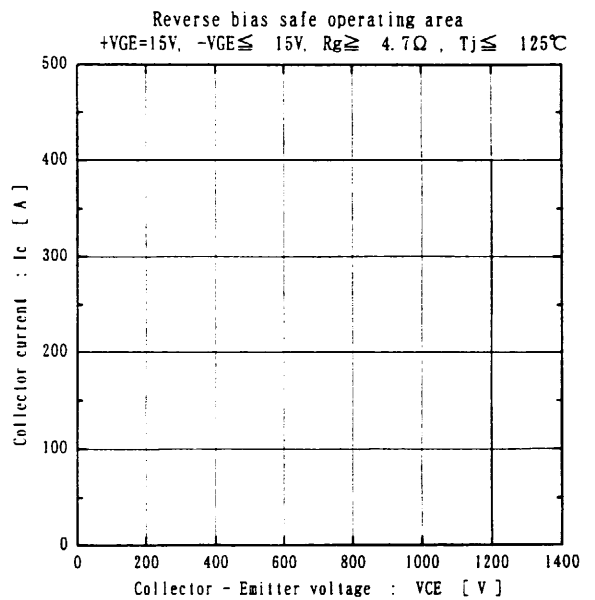
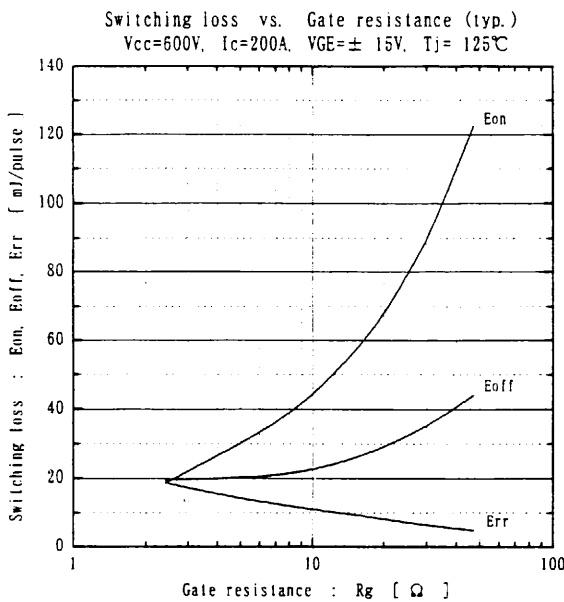
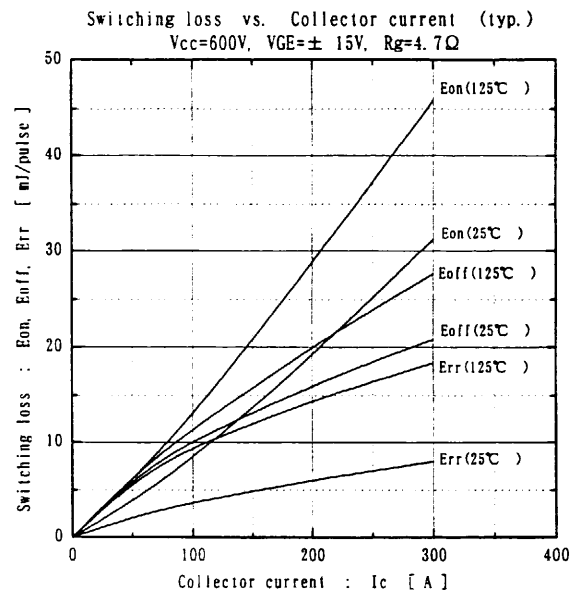
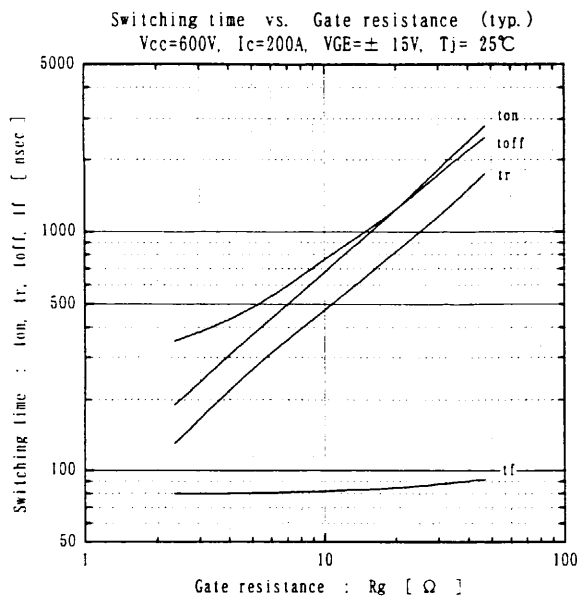
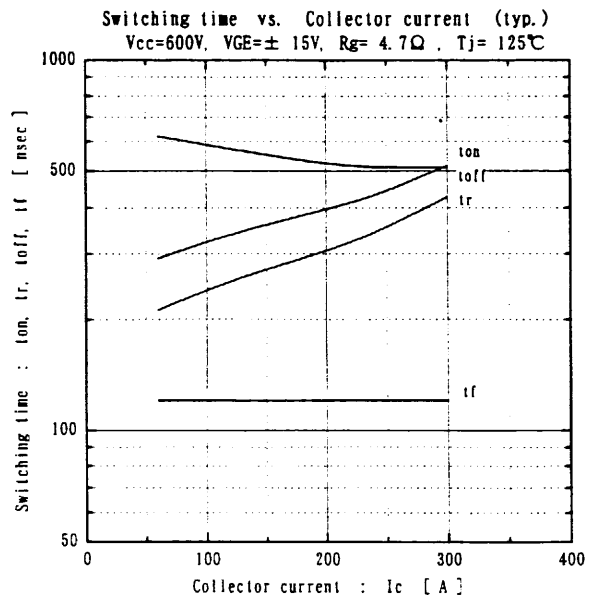
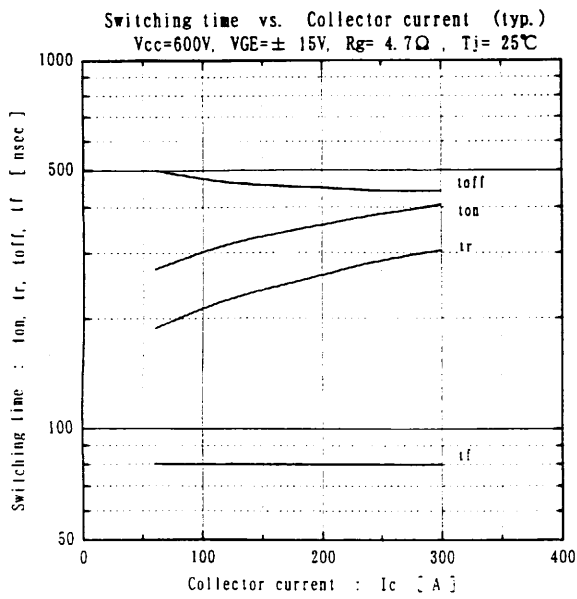
Note :

- This specification is only for technical considerations, and not for contract.
- This specification is subject to be changed without notices.



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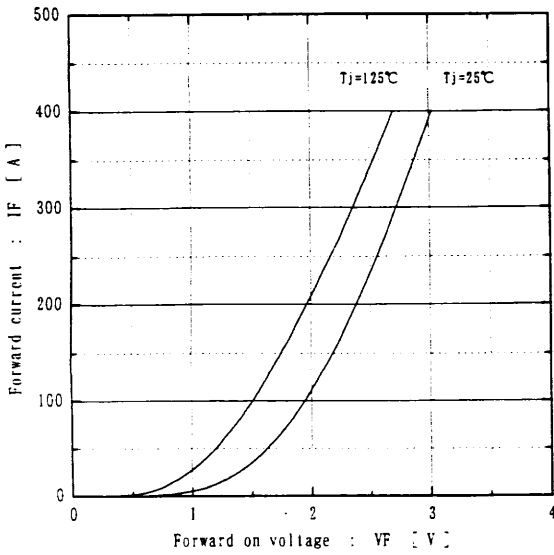
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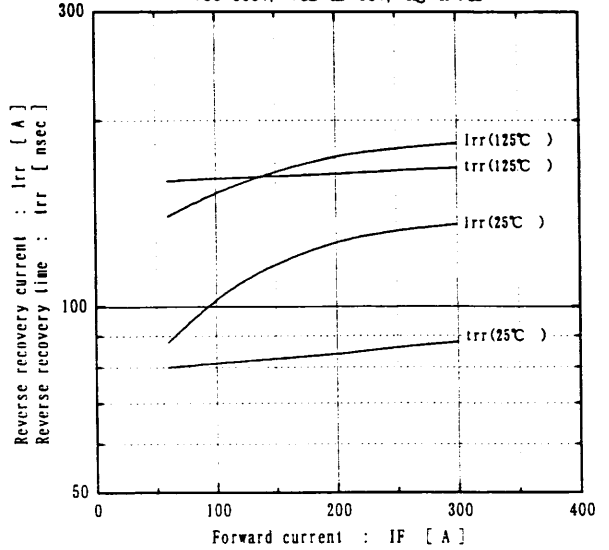
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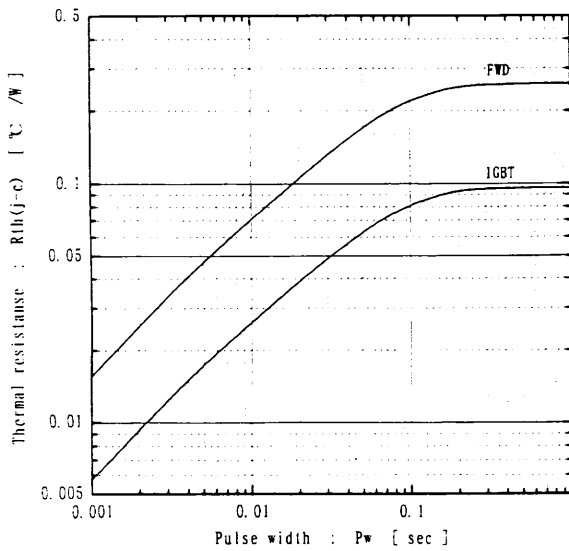
Forward current vs. Forward on voltage (typ.)



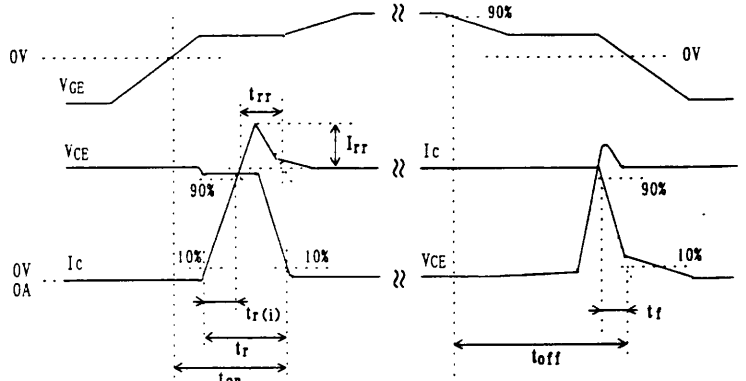
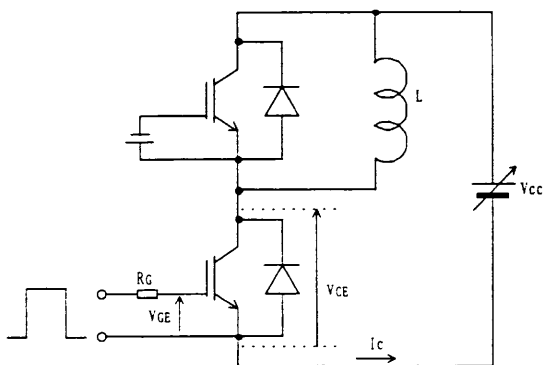
Reverse recovery characteristics (typ.)  
Vcc=600V, VGE=±15V, Rg=4.7Ω



Transient thermal resistance



Definitions of switching time



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